

#### **Features**

- Epoxy Meets UL 94 V-0 Flammability Rating
- · Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

# **Maximum Ratings**

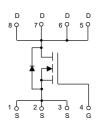
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 4.2°C/W Junction to Case (Note 2)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	V
Gate-Source Volltage		V <sub>GS</sub>	±20	V
Continuous Drain Current	T <sub>C</sub> =25°C	1	16	Α
	T <sub>C</sub> =100°C	- I <sub>D</sub>	11	Α
Pulsed Drain Current (Note 3)		I <sub>DM</sub>	50	Α
Single Pulse Avalanche Energy (Note 4)		E <sub>AS</sub>	70	mJ
Total Power Dissipation		P <sub>D</sub>	30	W

#### Note:

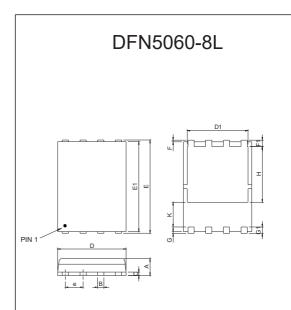
- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2. Surface Mounted on FR4 Board, t ≤10 sec.
- 3. Pulse Width Limited by Maximum Junction Temperature.
- 4. EAS Condition: TJ=25°C,VDD=15V,VG=10V,L=0.1mH,Rq=25 $\Omega$ .

# **Internal Structure and Marking Code**





# N-CHANNEL MOSFET



	DIMENSIONS				
DIM	INC	HES	MM		NOTE
DIIVI	MIN	MAX	MIN	MAX	NOTE
Α	0.035	0.047	0.90	1.20	
В	0.012	0.020	0.30	0.51	
С	0.007	0.010	0.19	0.25	
D	0.189	0.209	4.80	5.30	
D1	0.157	0.173	4.00	4.40	
Е	0.232	0.244	5.90	6.20	
E1	0.217	0.228	5.50	5.80	
е	0.050		1.27		TYP.
F	0.002	0.012	0.05	0.30	
F1	0.014	0.030	0.35	0.75	
G	0.002	0.012	0.05	0.30	
G1	0.014	0.030	0.35	0.75	
Н	0.131	0.154	3.34	3.90	
K	0.030		0.762		



# Electrical Characteristics @ 25°C (Unless Otherwise Specified)

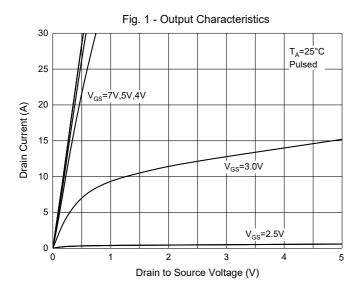
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static Characteristics			<u>'</u>		1		
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ =0V, $I_{D}$ =250 $\mu$ A	30	36		V	
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	μA	
Gate-Threshold Voltage <sup>(Note 5)</sup>	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1	1.6	3	V	
	В	V <sub>GS</sub> =10V, I <sub>D</sub> =10A		7	9	mΩ	
Drain-Source On-Resistance <sup>(Note 5)</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A		10.5	14		
Forward Tranconductance <sup>(Note 5)</sup>	<b>g</b> FS	$V_{DS}$ =5V, $I_{D}$ =8A	15			S	
Dynamic Characteristics(Note 6)			·				
Input Capacitance	C <sub>iss</sub>			1530			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =15V,V <sub>GS</sub> =0V,f=1MHz		250		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			198			
Total Gate Charge	Qg			15			
Gate-Source Charge	$Q_{gs}$	$V_{DS}$ =15V, $V_{GS}$ =10V, $I_{D}$ =9A		3		nC	
Gate-Drain Charge	$Q_{gd}$			4.5			
Turn-On Delay Time	t <sub>d(on)</sub>			10			
Turn-On Rise Time	t <sub>r</sub>	V <sub>DD</sub> =15V,I <sub>D</sub> =10A		8		ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{GEN}$ =1.8 $\Omega$		30			
Turn-Off Fall Time	t <sub>f</sub>			5			
Drain-Source Body Diode Cha	racteristi	cs		•			
Continuous Body Diode Current	Is				25	Α	
Body Diode Voltage (Note 5)	V <sub>SD</sub>	I <sub>SD</sub> =10A, V <sub>GS</sub> =0V		0.85	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> =25°C, I <sub>F</sub> =10A		22	35	ns	
Reverse Recovery Charge	Q <sub>rr</sub>	di/dt=100A/µs		12	20	nC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic Turn-On Time is Negligible (Turn-On is Dominated by LS+LD)					

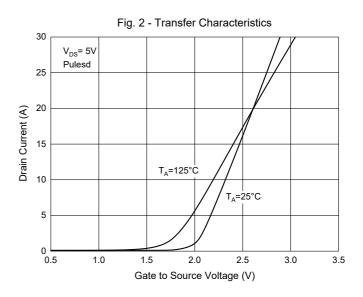
Note 5. Pulse Test : Pulse Width  $\leq\!300\mu s,$  Duty Cycle  $\leq\!2\%.$ 

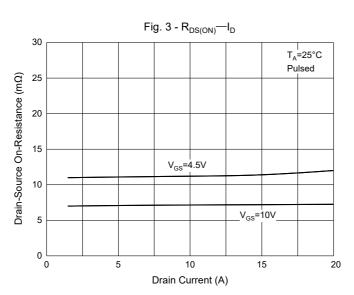
<sup>6.</sup> Guaranteed by Design, Not Subject to Production Testing.

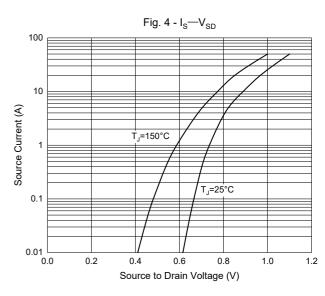


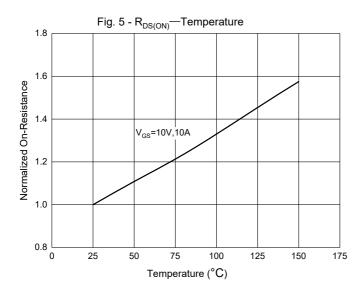
### **Curve Characteristics**

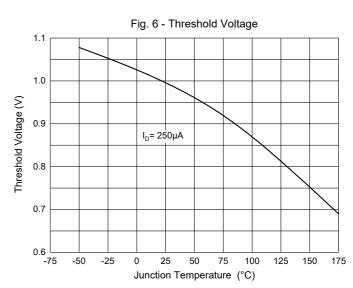














# **Ordering Information**

Device	Packing	
Part Number-TP	Tape&Reel: 2.5Kpcs/Reel	

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